

Photosensors: new developments and applications

Institute for Nuclear Physics, Karlsruhe Institute of Technology

Parallel session at „**HAP Topic 4 Advanced technology**“ workshop
Karlsruhe, 24-25 January, 2013

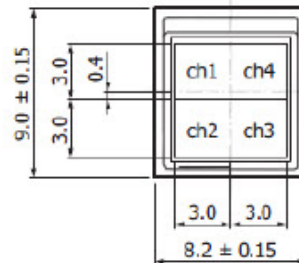
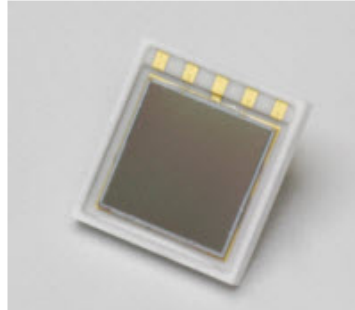
Parallel session: ~10 attendees, main focus on SiPM (Tim Niggemann)



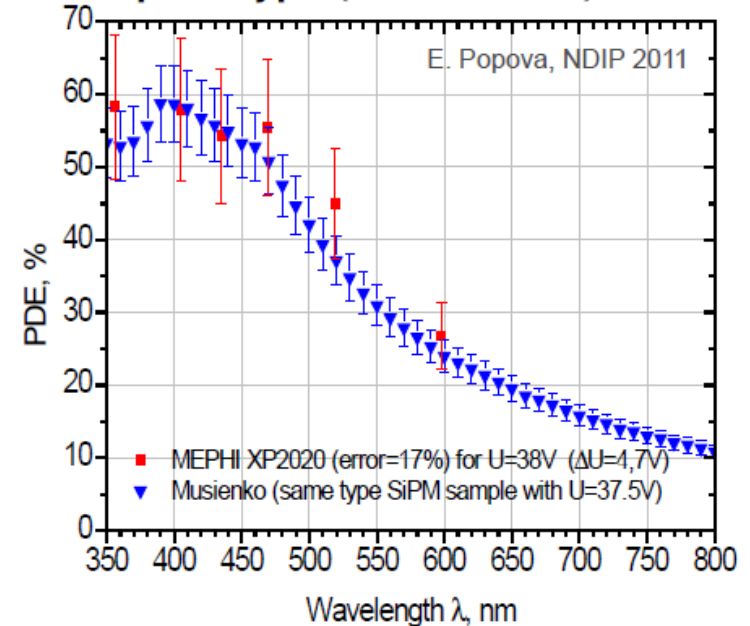
Photon Detection Efficiency of SiPMs

Hamamatsu S10985-100C

- ▶ 3600 cells
- ▶ PDE in UV regime \approx 25 % – 36 %
- ▶ Extensively studied in our laboratories
- ▶ **Used for FAMOUS**



SiPM prototype (MEPhi 100B)



Very high PDE in UV regime up to 60 %
Not yet commercially available!

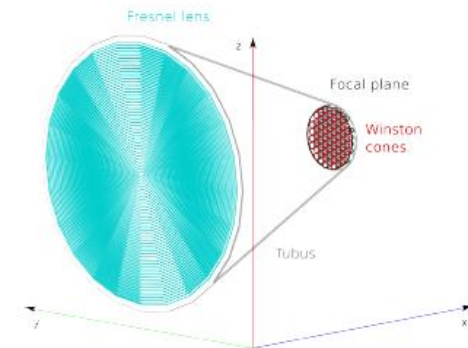
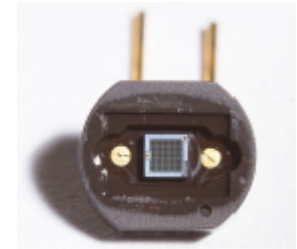
SiPM's:

- Low bias voltage ($<100V$)
- Low power consumption
- Gain $10^5 - 10^7$
- PDE: 30-40%, up to 60% (UV)

PMT's:

- High bias voltage (1000V)
- Gain $10^6 - 10^7$
- PDE: up to 35% (UV)

- **Cross-talk:** At breakdown a micro-plasma is formed and e^- are lifted to high bands \rightarrow relax with photon emission.
- **Afterpulses:** during the breakdown deep traps in the silicon are filled with carriers which are subsequently released.
- **Dark counts:** initiated by thermal generation or field-assisted generation (tunneling) of free carriers



Example: Ketek PM3350

DEVICE CHARACTERISTICS

GEOMETRICAL DATA	STANDARD	TRENCH
Active Sensor Area	3.0 x 3.0 mm ²	
Micropixel Size	50 x 50 μm ²	
Number of Pixel	3600	
Geometrical Efficiency	70 %	60 %

SPECTRAL PROPERTIES

Spectral Range	300 to 800 nm	
Peak Wavelength	420 nm	
PDE ² at 420 nm	≥ 50 %	≥ 40 %
Gain ¹ M	~ 2 x 10 ⁶	
Temp. Coefficient ¹	$ \frac{1}{M} \cdot \frac{\partial M}{\partial T} \leq 1 \text{ } ^\circ\text{C}^{-1}$	
Dark Rate ¹	≤ 500 kHz/mm ²	≤ 300 kHz/mm ²
Crosstalk ¹	~ 35 %	~ 20 %

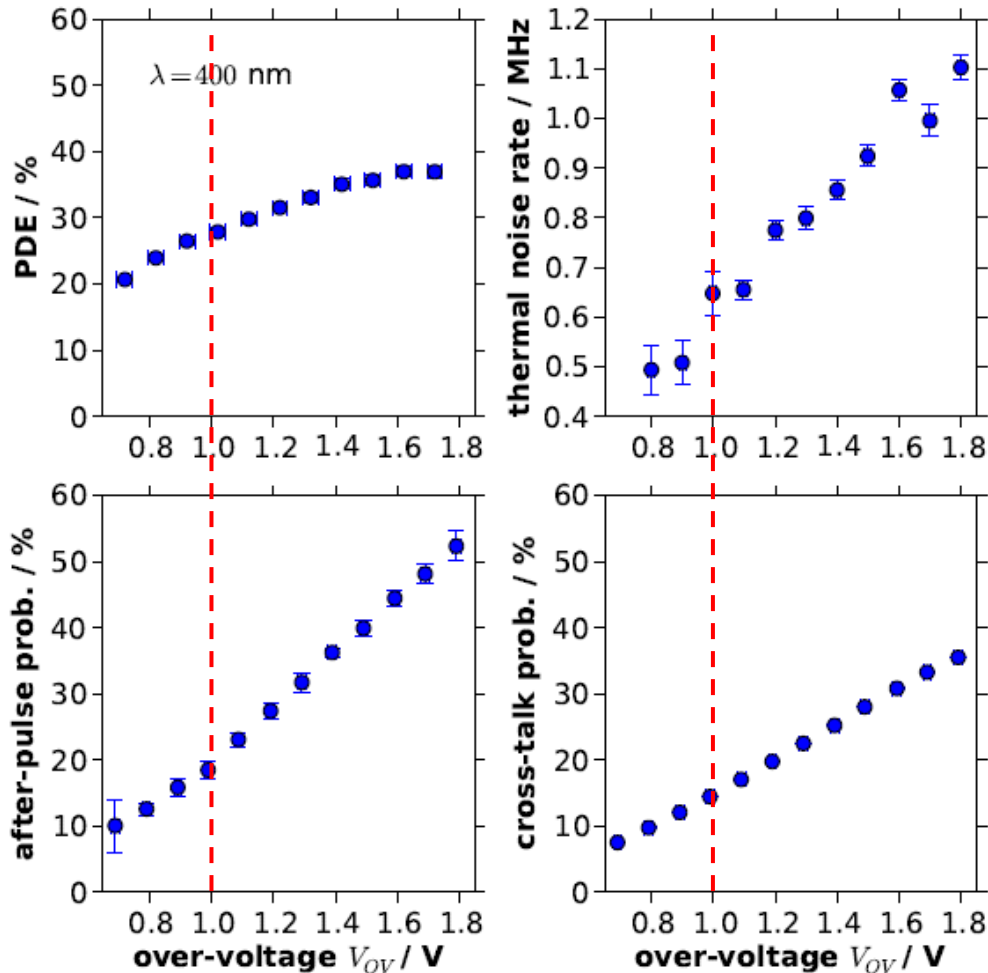
ELECTRICAL PROPERTIES

Breakdown Voltage	27 (typ.) V	23 (typ.) V
Operation Voltage	20 % rel. Overvoltage	

(1) at 20% Overvoltage

(2) PDE measurement based on zero peak Poisson statistics; value not affected by cross talk

Cross-talk, afterpulses, temperature dep.



Overvoltage dependency of the Hamamatsu S10362-11-100C

$$V_{OV} = V_{\text{applied}} - V_{\text{breakdown}}$$

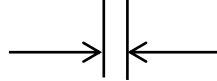
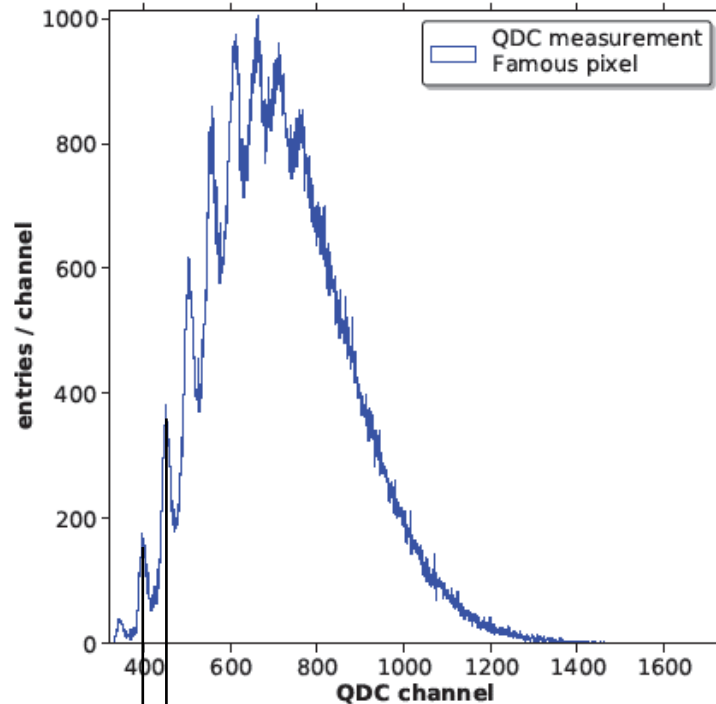
To remember: the breakdown Voltage changes with temperature, i.e. with constant $V_{\text{applied}} \rightarrow V_{OV}$ changes

e.g. gain changes too

e.g. 1V \rightarrow 15% cross-talk

Gain control possibility

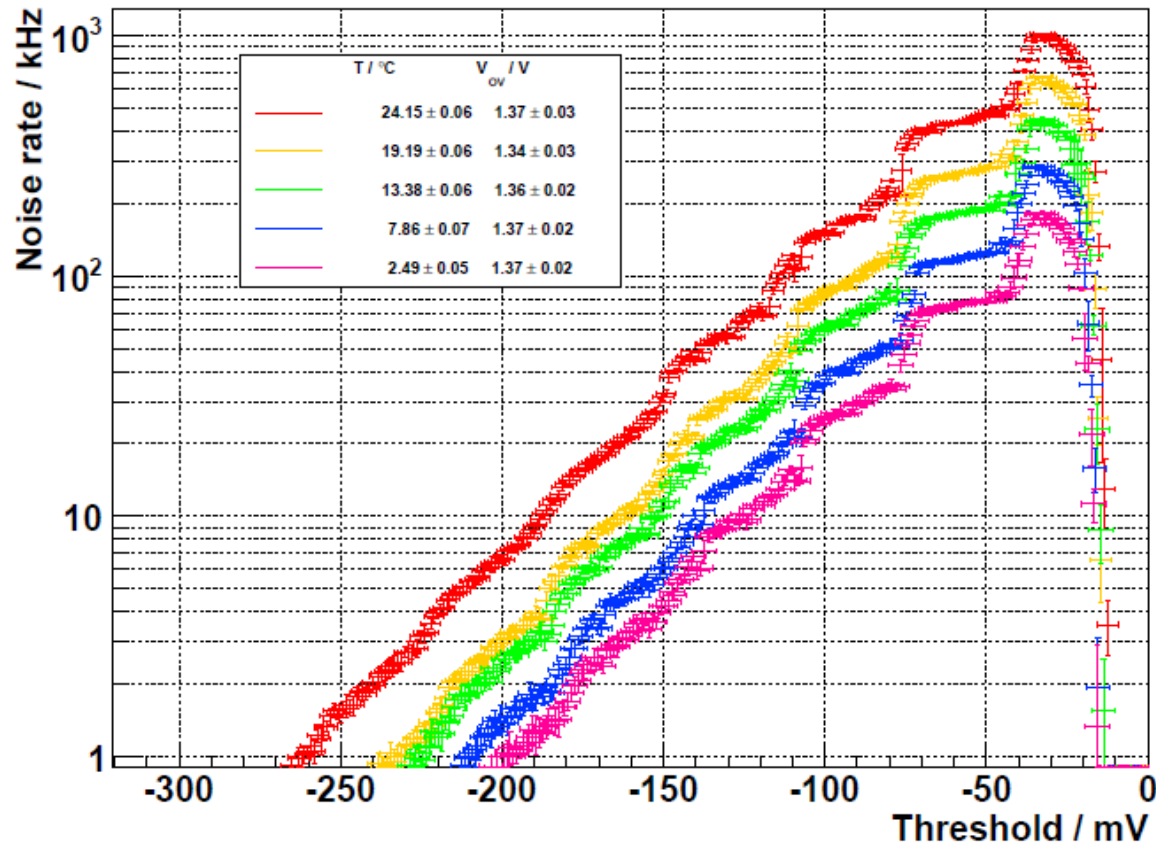
Charge Spectrum of a measurement
with a pulsed UV LED



Space between peaks depends on gain, i.e.
possible control of gain fluctuations

Temperature dependence: Noise rate

Noise Rate vs. Threshold (HAM. S103612-11-100C SN.1203)



⇒ The rate reduces in first order by a factor of 2 every 8°C

⇒ It is of advantage to cool SiPM's down BUT one needs double glazing to avoid moistures, i.e. the transparency is also reduced

Thermal noise rate vs. threshold for various temperatures T and constant overvoltage V_{OV} . Bachelor Thesis Johannes Schumacher

Simulation codes for SiPM

- **G4SiPM** – developed by the Auger and CMS groups in Aachen
 - based on Geant4
 - publicaly available soon (+ publication)

- Another one developed in Uni-Heidelberg:



GosSiP - Generic framework for the simulation of Silicon
Photomultipliers

<http://www.kip.uni-heidelberg.de/hep-detektoren/gossip>

- downloadable for free for Linux
- ROOT based (root.cern.ch)

,Big' players, i.e. SiPM producers

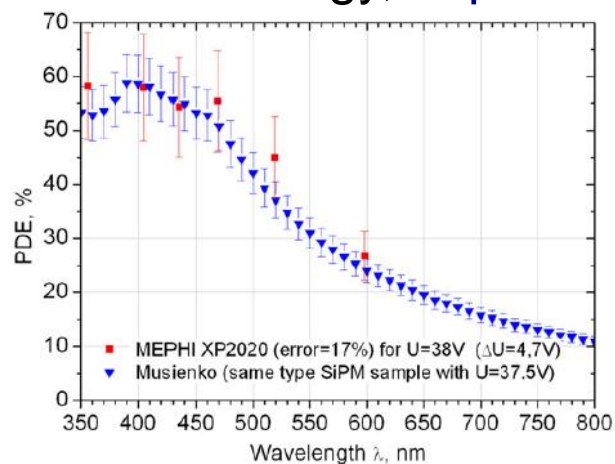
1. Hamamatsu Photonics, <http://www.hamamatsu.com/>



2. KETEK , <http://www.ketek.net/>
Headquarter: Munich, Germany



3. Excelitas Technology, <http://www.excelitas.com>



- PDE ~60% (400 nm)
- Cross-talk 3-5%
- Sensitivity of gain as $f(T)$ 0.5%/°C
- Produced by MEPhI with strong help of EXCELITAS
- [NIM A 695 \(2012\) 40-43](#)

Fig. 4. The measured PDE of SiPM of type 100B. Square boxes: measurement performed in MEPhI, triangles: measured by Y. Musienko.

Conference / More info...

Passed one but good source of information:

New Developments in Photodetection

(NDIP 2011, Lyon France), <http://www.ndip.fr/>

Proceedings: ***NIM A 695, p.1-444 (11 December 2012)***



- devoted to the latest developments in photodetection techniques down to single photon, over the entire electromagnetic spectrum
- *Detectors*: Photomultiplier Tubes, Hybrid photodetectors, Silicon Photomultiplier devices, solid-state detectors, gaseous photodetectors, polymer detectors and new sensing media,
- *Systems and instruments*: pixel arrays, front-end electronics, signal and image processing and fast timing techniques.

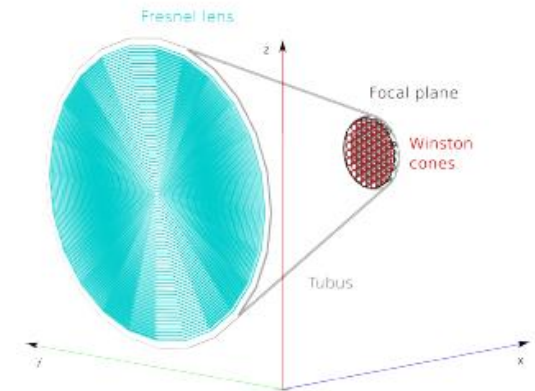
SPIE: is the international society for optics and photonics

- Organize conferences, exhibitions, educational material
- <http://www.spie.org>



Some other questions ...

- What radioactive purity one can achieve with SiPM photosensors?
=> unknown but probably low. Any one else knows?
- Seems to be fine at temperatures of LXe (Xenon1T R&D ?), even better for the noise!
- One has to be careful with the Fresnel lens
-> easy to scratch!
- Can be operated in high magnetic fields, e.g. 4T
- Recovery time $\sim 30\text{ns}$ (Capacitance of the cell x Quenching resistor)
- Costs (example): some 200-300 EUR / SiPM ($6 \times 6 \text{ mm}^2$)
- Group in Aachen is the only one from HAP to work with SiPM (partners in Granada and Lisbon)



Original notes, questions

'Start': What we may discuss

- What is demand from our physics, i.e. Neutrinos, Cosmic rays, Dark matter searches, ...?
- What radioactive purity one can achieve with various photosensors? Any numbers?
- How large areas can be covered? QE, geometry efficiency, dark current?
- Special requirements for Electronics / DAQ?
- Operation of photosensors at low temperatures, e.g. LXe, 10mK?
- Simulation of photosensors, what packages are used, their advantages/disadvantages, someone experience (COMSOL)?
- Operation in strong magnetic field (e.g. 9T)?
- How can we benefit from HAP-internal collaborations?
- ...

Discussion #1

Discussion on SiPM, what are disadvantages (Tim Niggemann):

- cross-talk in SiPM depends on overvoltage, optimal parameters 1V \rightarrow 15% due to a recombination of e⁻ which happens with a photon emission
- Question of afterpulses
- KETEK PM3350
- New developments of Hamamatsu, replace the resistor with transparent film
- Temperature changes breakdown voltage, but can be corrected
- Costs: 10 for 350EUR each, then 250EUR each (6x6mm²)
- Cooling chamber to reduce thermal noise, but if one goes <10C one has to avoid a moisture: double glazing
- 1 photon / ns / per pixel
- Trigger efficiency of FAMOUS: 10 showers per night with $E \sim 10^{17} \text{eV}$
- Filter plate made of UG11
- Simulations: GosSiP another available code (ROOT based, GUIs)
- Studies of afterpulses: can be two-three components but analytical formula exist to fit it
- Recovery time 30ns (Capacitance of the cell x Quenching resistor)
- Tests up to 4T, also at T(LXe) (temperature noise basically zero)
- How many groups: Aachen, Granada, Lisbon

Discussion #1

- MEPhI more concentrated on gain stability, noise level but cross-talk isn't known. Patent is sold to a company

Question again and again: what is the temperature dependence?

- Breakdown voltage decreases with temperature
- Noise Rate vs. Threshold (HAM S103612-11-100C):
Noise rate /kHz goes down by factor of 2 with every 8C.
- Fernel lense very sensitive to scratches, reflective optics is the way to go

SPIE:

Discussion #2

About PMT's

- Tests of linearity, was it done at different voltages
- Afterpulses were measured at the same gain of different PMTs